

Basic Board Mount Pressure Sensors

ABP Series—High Accuracy, Compensated/Amplified

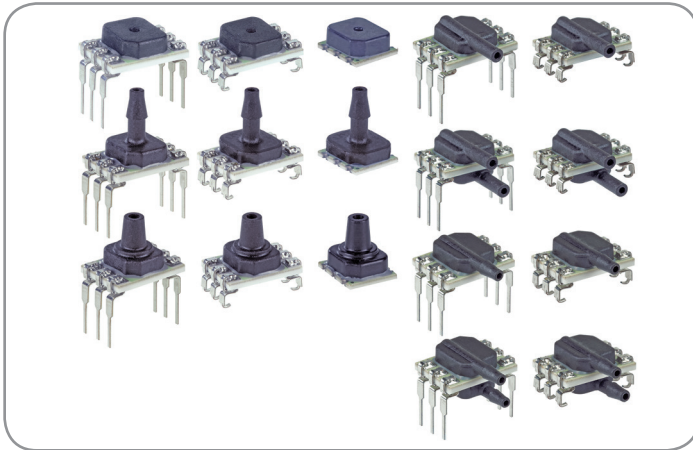
60 mbar to 10 bar | 6 kPa to 1 MPa | 1 psi to 150 psi

Digital or Analog Output, Liquid Media Capable

32305128

Issue E

Datasheet



DESCRIPTION

The ABP Series are piezoresistive silicon pressure sensors offering a ratiometric analog or digital output for reading pressure over the specified full scale pressure span and temperature range. They are calibrated and temperature compensated for sensor offset, sensitivity, temperature effects and accuracy errors (which include non-linearity, repeatability and hysteresis) using an on-board Application Specific Integrated Circuit (ASIC). Calibrated output values for pressure are updated at approximately 1 kHz for analog and 2 kHz for digital. All products are designed and manufactured according to ISO 9001 standards.

- Dry gases option: The input port is limited to non-corrosive, non-ionic media (e.g., dry air, gases) and should not be exposed to condensation. The gases are limited to media compatible with high temperature polyamide, silicone, alumina ceramic, silicon, gold, and glass.
- Liquid media option: Includes an additional silicone-based gel coating to protect the electronics under port P1, which enables use with non-corrosive liquids (e.g. water and saline) and in applications where condensation can occur. Since port P2 is designed for use with non-corrosive liquids, this option is often suitable for wet-wet differential sensing.

VALUE TO CUSTOMERS

- Simplifies design-in: Small size saves room on the PC board (PCB), or simplifies design in smaller and lower power devices. Meets Moisture Sensitivity Level 1 requirements, which allows for unlimited shelf life when stored at <30 °C/85 %RH and, under most storage conditions, allows for PCB soldering without any material concern about solder joint quality due to aging of the sensor terminals, which minimizes the concern about aging of the terminals prior PCB assembly. Pressure choices allow engineers to select range required for their application. Leadless SMT, SMT, and DIP package options.
- Cost-effective: Small size helps engineers reduce design and manufacturing costs while maintaining enhanced performance and reliability of the systems they design.
- Accurate: Total Error Band (TEB) and wide pressure range enable engineers to optimize system performance by

improving resolution and system accuracy. Optional internal diagnostics validate that the sensor readings are correct.

- Flexible: Supply voltage range, variety of pressure units, types, and ranges, output options, and wide operating temperature range simplify use in the application.
- Versatile: Wet-media compatibility, sleep mode, and temperature output options make the sensor a versatile choice for Internet of Things applications.
- Honeywell Brand: Utilize proprietary Honeywell technology, and are protected by multiple global patents.

DIFFERENTIATION

- Enhanced accuracy helps the design engineer fully understand the error in measurement.
- Wide supply voltage range offers design flexibility.
- Power consumption when utilizing sleep mode option allows for use in battery-powered applications.

FEATURES

- Measure gage and differential pressures
- Total Error Band (see Figure 1): $\pm 1.5\%$ FSS
- Liquid media option: Allows for wet/wet operation on dual ported devices
- Industry-leading long-term stability: $\pm 0.25\%$ FSS
- Industry-leading accuracy: $\pm 0.25\%$ FSS BFSL
- Wide pressure range: 60 mbar to 10 bar | 6 kPa to 1 MPa | 1 psi to 150 psi
- As small as 8 mm x 7 mm
- High burst pressures (see Table 7)
- Calibrated over temperature range of 0°C to 50°C [32°F to 122°F]
- Operates from a single power supply of either 3.3 Vdc or 5.0 Vdc
- Output: Ratiometric analog or I²C- or SPI-compatible 12-bit digital
- Power consumption: 2 uA typical when utilizing sleep mode option
- Meet IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level 1 requirements
- REACH and RoHS compliant
- Options: Internal diagnostic function, liquid media, sleep mode, temperature output

POTENTIAL APPLICATIONS

- **Medical:** CPAP, blood analysis, blood pressure monitoring, breast pumps, drug dosing, hospital beds, massage machines, oxygen concentrators, patient monitoring, sleep apnea equipment, urine analyzers, ventilators/portable ventilators, and wound therapy
- **Industrial:** Air brakes, HVAC/transmitters, life sciences, material handling, pneumatic control and regulation, process gas monitoring, and valve positioning/positioners
- **Commercial:** Air beds, coffee makers, and washing machines

PORTFOLIO

The Basic ABP Series is an addition to the following portfolio of board mount pressure sensors: Basic NBP Series, Basic TBP Series, TruStability™ HSC Series, TruStability™ SSC Series, TruStability™ TSC Series, and TruStability™ NSC Series.

Basic Board Mount Pressure Sensors, ABP Series

Figure 1. Total Error Band

Total Error Band (TEB) is a single specification that includes all possible sources of error. TEB should not be confused with accuracy, which is actually a component of TEB. TEB is the worst error that the sensor could experience. The TEB specification on a datasheet may be confusing. Honeywell uses the TEB specification in its datasheet because it is the most comprehensive measurement of a sensor's true accuracy. Honeywell also provides the accuracy specification in order to provide a common comparison with competitors' literature that does not use the TEB specification. Many competitors do not use TEB—they simply specify the accuracy of their device. Their accuracy specification, however, may exclude certain parameters. On their datasheet, the errors are listed individually. When combined, the total error (or what would be TEB) can be significant.

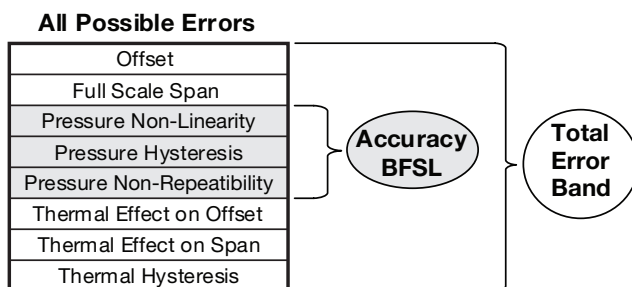


Table 1. Absolute Maximum Ratings¹

Characteristic	Min.	Max.	Unit
Supply voltage (V_{supply})	-0.3	6.0	Vdc
Voltage on any pin	-0.3	$V_{\text{supply}} + 0.3$	V
Digital interface clock frequency:			
I ² C	100	400	kHz
SPI	50	800	
ESD susceptibility (human body model)	2	—	kV
Storage temperature	-40 [-40]	85 [185]	°C [°F]
Soldering time and temperature:			
lead solder temperature (DIP)		4 s max. at 250°C [482°F]	
peak reflow temperature (Leadless SMT, SMT)		15 s max. at 250°C [482°F]	

¹Absolute maximum ratings are the extreme limits the device will withstand without damage.

Table 2. Environmental Specifications

Characteristic	Parameter
Humidity: all external surfaces internal surfaces of Liquid Media Option (T and V) internal surfaces of Dry Gases Option (N and D)	0 %RH to 95 %RH, non-condensing 0 %RH to 100 %RH, condensing 0 %RH to 95 %RH, non-condensing
Vibration	15 g, 10 Hz to 2 kHz
Shock	100 g, 6 ms duration
Life ¹	1 million pressure cycles minimum
Solder reflow	J-STD-020-D.1 Moisture Sensitivity Level 1 (unlimited shelf life when stored at $\leq 30^\circ\text{C}/85\% \text{RH}$)

¹Life may vary depending on specific application in which the sensor is used.

Table 3. Wetted Materials¹

Component	Pressure Port 1 (P1)		Pressure Port 2 (P2)
	Dry Gas Option	Liquid Media Option	
Ports and covers	high temperature polyamide		
Substrate	alumina ceramic	—	alumina ceramic
Adhesives	epoxy, silicone	epoxy, silicone gel	epoxy, silicone
Electronic components	silicon, glass, solder, gold, aluminum	304 SST	silicon

¹Contact Honeywell Customer Service for detailed material information.

Table 4. Sensor Pressure Types

Pressure Type	Description
Gage	Output is proportional to the difference between applied pressure and atmospheric (ambient) pressure.
Differential	Output is proportional to the difference between the pressures applied to each port (Port 1 – Port 2).